

2023 Scholarship Application -High School

Name of Scholarship:

Li S. Liu, P.E. Memorial Scholarship

This scholarship is given annually to a high school senior from Western New York who is accepted into an accredited engineering program.

Richard Wohler, P.E. Memorial/ Hutch-Tech High School Scholarship

This scholarship is presented annually to a senior with preference towards a student from Hutch Tech High School or a High School in Buffalo, NY who is accepted into an accredited engineering program.

Note: Deadline for submission is: March 24, 2023

<u>PERSONAL INFORMATION</u> (Include name and <u>last 4 digits only</u> of social security number on each page of application and attachments).

Name:					
Last		First		Middle	
Home Address:					
			ber/street)		
((City/state	z/zip code)			
Phone #: (.)		E-mail:		
Date of Birth: _	/	/ SS#: _			_(last 4 digits only!)

Last 4	Digits	of Social	Security	Number	

Y N

Name

ACADEMIC INFORMATION:			
High School:			
Phone #: (
Cumulative Grade Point Average:	; Scale (Ex: 4.0	or 100%):	
SAT or ACT Scores (required):			
Please attach a copy of the official to	esting agency gra	de report.	
NOTE TO APPLICANT: To be eligible applicants must plan to attend and be accaccredited by the Engineering Accreditation Engineering and Technology (ABET-EAC) program is not ABET-EAC accredited. ABET web page at www.ABET.org. SCHOOLS APPLIED TO (See Note to Application of the second	cepted in an eng Commission of th . An applicant m Γ-accredited school	rineering program that he Accreditation Board hay be disqualified if	at is d for the
Institution	_	Accepted	
	Date Applied	-	
	/	Y N	
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____/___

Planned Engineering Major: _____

EXTRACURRICULAR & VOLUNTEER ACTIVITIES:

<u>On a separate sheet</u>, please list on/off campus extracurricular activities and community-related volunteer activities during high school, including any position held, such as President, Secretary, etc., using this format.

Month/Year to Month/Year (most recent first)	Activity	Most Significant Contribution

WORK EXPERIENCE:

<u>On a separate sheet</u>, please list employment during school and summer break. Submit additional sheet if necessary, using this format.

Month/Year to Month/Year (most recent first)	Place of Employment Name of Supervisor/Ph. No.	Job Duties/Hours Worked

HONORS AND SCHOLARSHIPS:

<u>On a separate sheet</u>, please list any academic or non academic-related honors and/or scholarships, using this format.

Month/Year	Sponsor	Name of Award	Reason for Receipt of Award

FINANCIAL INFORMATION:

How do you plan to finance your education and living expenses for the current school year?

- <u>Option 1</u>: Please attach a copy of your Student Aid Report (SAR) from their FAFSA.
- Option 2: Please complete the table below:

Item	Estimated Cost	Savings	Grants	Scholarships	Family Support	Loans y legally obligate repay	
Tuition/ Fees	\$	%	%	%	%	%	=100%
Books/ Supplies	\$	%	%	%	%	%	=100%
School Year Living Expenses	\$	%	%	%	%	%	=100%

Do you have any family/financial responsibilities that NSPE should consider when reviewing your application? (If necessary, use additional sheet.)						
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Please list the name(s)/address of at least two people who will forward mail to	you.
Name	
Address	
	_
Relationship	
Name	
Address	
	-
Relationship	

Last 4 Digits	of Social	Security	Number	

Name

ESSAY: The essay should discuss your interest in engineering, your major area of study and area of specialization, and the occupation you propose to pursue after graduation. What are your long-term goals and how do you hope to achieve them? The essay may also include any other information that is relevant to your career plans. The essay should be a typewritten or computer-printed essay of no more than 500 words, double-spaced. Put your name and major field of engineering at the top of the page.

Assemble the application in the following order. Do not use a report binder.

- 1. Application
- 2. Recommendations of Teachers (at least two)
- 3. Employer Recommendation (optional)
- 4. Essay (maximum 500 words)
- 5. One Official High School Transcript (must be in sealed envelope)
- 6. SAT/ACT Scores: Please attach one official score sheet.

REQUIRED INFORMATION Applications without required materials and signatures will be disqualified.

Scholarship Applicant: I authorize my school officials to give information about my academic records to NSPE. Yes_____ No____ To the best of my knowledge, the information presented on this application is complete and true. (Applicant's Signature) Date

Principal/Guidance Counselor Certification:

I certify that the applicant is a U.S. citizen.

I certify that the academic information presented on this application is complete and true and that the applicant meets the stated eligibility requirements.

Signature:
Printed Name:
Title:
High School:
Phone #: (
Date:

The following criteria will be used by Erie-Niagara NYSSPE as the basis for selecting scholarship winners.

Total:	100 points
SAT/ACT scores	20 points
Composite application	10 points
Financial need	15 points
Applicant's activities, work experience during school and summer break	15 points
Essay on career plans (maximum 500 words)	20 points
Recommendation of at least two teachers	Required
Grade Point Average (GPA)	20 points

Completed Scholarship Application must be postmarked or hand delivered to the address below on or before <u>March 24, 2023.</u>

Mail your complete application package to:

Anthony J. Dell'Isola, P.E. Scholarship Committee Chairperson New York State Society of Professional Engineers Erie-Niagara Chapter 7270 Ridgeview Drive West North Tonawanda, NY 14120